

Integrated Board



Super X11DPT-PS

Views: | <u>Angled View</u> | <u>Node View</u> | | <u>Front View</u> | <u>Rear View</u> |

Certification Matrix
Card (AOC) Matrix

Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.



Key Features

- Compute Intensive Application
- HPC, Data Center
- Enterprise Server
- Financial Analysis
- Mission-critical applications

Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 1. Dual Socket P (LGA 3647) support 2nd Gen Intel® Xeon® Scalable processors (Cascade Lake/Skylake)‡
- 2. 16 DIMMs; up to 4TB 3DS ECC DDR4-2933MHz[†] RDIMM/LRDIMM, Supports Intel® Optane™ DCPMM^{††}
- 3. 2 PCI-E 3.0 x16 (LP) slots
- 4. Flexible Networking support via SIOM; Dedicated IPMI 2.0 LAN
- 5. 6 Hot-swap 2.5" SATA3 drive bays
- 6. Up to 2200W Redundant Power Supplies Titanium Level (96%)

Specifications

0\/0.00055.55	00	France E. 1	OLI De alemanent
SYS-2029TP-HTR	■ SuperServer 2029TP-HTR (Black)	Form Factor	■ 2U Rackmount
Notherboard (Four per S	Suctom)	Model	■ CSE-217HQ+-R2K20BP3
	3/3(6111)	Dimensions and Weight	
Super X11DPT-PS		Width	17.75" (429mm)
Processor/Cache (per N	ode)	Height	■ 17.25" (438mm) ■ 3.47" (88mm)
CPU	■ Dual Socket P (LGA 3647)	Depth	■ 28.5" (724mm)
CPU	2nd Gen Intel® Xeon® Scalable Processors and Intel® Xeon® Scalable Processors [‡] , Dual UPI up to 10.4GT/s	Weight	■ Gross Weight: 90 lbs (40.9kg)
			■ Net Weight: 72 lbs (32.7 kg)
	■ Support CPU TDP 70-165W*	Available Colors	■ Black
Cores	■ Up to 28 Cores		
Note	* Please contact Supermicro Technical Support for supporting conditions of high power (TDP 150W and above)	Front Panel	
	or high base frequency (3.0 GHz and above) processors.	Buttons	■ Pow er On/Off button ■ UID button
Note	[‡] BIOS version 3.2 or above is required to support 2nd Gen Intel® Xeon® Scalable processors (codenamed Cascade	LEDs	■ Pow er status LED
	Lake-R)		 HDD activity LED Network activity LEDs
			Universal Information (UID) LED
System Memory (per No	ode)		
Memory	 16 DIMM slots Up to 4TB 3DS ECC DDR4-2933MHz† RDIMM/LRDIMM 	Expansion Slots (per Node)	
Capacity	 Up to 41B 3DS ECC DDR4-2933MHz1 RDIMWLRDIMM Supports Intel® Optane™ DCPMM^{††} 	PCI-Express	2 PCI-E 3.0 x16 Low-profile slots
Memory Type	■ 2933 [†] /2666/2400/2133MHz ECC DDR4 RDIMWLRDIMM		 1 SIOM card support Note: Barebones and Complete System must bundle with
Note	† 2933MHz in two DIMMs per channel can be achieved by		Network Card
	using memory purchased from Supermicro †† Cascade Lake only. Contact your Supermicro sales rep		(With only one CPU installed, SXB2 M.2 and SXB4 rise
	for more info.		card slots not function)
		Drive Bays (per Node)	
On-Board Devices (per N	lode)	Hot-swap	■ 6 Hot-sw ap 2.5" SATA3 drive bays
Chipset	■ Intel® C621 chipset	110τ-3 Ψ αρ	The Swap 2.5 On the directorys
SATA	■ SATA3 (6Gbps); RAID 0, 1, 5, 10 support	System Cooling	
Network Controllers	 Barebones and Complete System must have at least one SIOM or network card installed per node 	Fans	■ 4 Heavy duty 8cm PWM fans with optimal fan speed
IPMI	■ Support for Intelligent Platform Management Interface v.2.0		control
	IPMI 2.0 w ith virtual media over LAN and KVM-over-LAN		
Graphics	support ASPEED AST2500 BMC	Power Supply	police with DMD us
Огаринся	A SI LLD A S12000 DIVIC	2200W Redundant Pow er Sul	1200W with Input 100-127Vac
Input / Output (per Node)		Power and Input	■ 1800W with Input 200-220Vac
SATA	■ 6 SATA3 (6Gbps) ports		1980W with Input 220-230Vac2090W with Input 230-240Vac
LAN	1 RJ45 Dedicated IPMI LAN port		2200W with Input 220-240Vac (for UL/cUL use only)
USB	2 USB 3.0 ports (rear)	AC Input	 2090W w ith Input 230-240Vdc (for CCC only) 50-60Hz
VGA	■ 1 VGA port	Frequency	■ 30-001Z
Serial Port /	■ 1 Fast UART 16550 port / 1 Header (internal)	Dimension	■ 76 x 40 x 336 mm
Header		(W x H x L)	Mary 400A (AF- 0A (400 407)()
Others	 2 <u>SuperDOM</u> support on the motherboard 1 NVMe or 2 SATA M.2 (22x80/60/42 mm) support with 	+12V	 Max: 100A / Min: 0A (100-127Vac) Max: 150A / Min: 0A (200-220Vac)
	option part: AOC-SMG3-2H8M2 M.2 and SuperDOM are for OS boot and they cannot		■ Max: 165A / Min: 0A (220-230Vac) ■ Max: 174.17A / Min: 0A (230-240Vac)
	 M.2 and SuperDOM are for OS poot and they cannot coexist 		Max: 183.3A / Min: 0A (220-240Vac)
		5VSB	■ Max: 1A / Min: 0A
System BIOS		Output Type	■ Backplanes (gold finger)
BIOS Type	■ AMI 32MB SPI Flash ROM	Certification	Titanium Level [Test Report]
			[lest keport]
Management			_
Software	■ Intel® Node Manager	Operating Environment	
	 IPMI 2.0 KVM with dedicated LAN 	RoHS	■ RoHS Compliant
	■ NMI ■ SSM, SPM, SUM	Environmental	Operating Temperature:
	 SuperDoctor® 5 	Spec.	10°C ~ 35°C (50°F ~ 95°F)
Power Configurations	Watchdog ACPI Pow er Management		■ Non-operating Temperature: -40°C to 60°C (-40°F to 140°F)
			■ Operating Relative Humidity:
<u> </u>			8% to 90% (non-condensing) Non-operating Relative Humidity:
PC Health Monitoring			5% to 95% (non-condensing)
CPU	Monitors for CPU Cores, Chipset Voltages, Memory.		
	■ 5+1 Phase-switching voltage regulator		
FAN	 Fans with tachometer monitoring Status monitor for speed control 		
	 Status monitor for speed control Pulse Width Modulated (PWM) fan connectors 		
Temperature	Monitoring for CPU and chassis environment		
	Thermal Control for fan connectors		
Omni Bath	Do not support		

Om ni-Path Fabric CPUs

■ Do not support

Parts List

Parts List - (Items Included)

	Part Number	Qty	Description
Motherboard / Chassis	MBD-X11DPT-PS CSE-217HQ+-R2K20BP3	<u>4</u> 1	Super X11DPT-PS Motherboards 2U Chassis
Backplane	BPN-ADP-6SATA3P	4	Backplan adapter card; 6SATA ports,RoHS/REACH,PBF
Backplane	BPN-SAS3-217HQ2	1	2U 24-Port 4-Node Backplane Supports 6x2.5
Cable 1	CBL-PWCD-0578	2	PWCD,US,IEC60320 C14 TO C13,3FT,14AWG
Air Shroud	MCP-310-21716-0B	4	Tw inpro X11 air shroud
Riser Card	RSC-P-6	4	RSC-P-6 (1U LHS Tw inPro RSC w ith 1 PCI-Ex16),RoHS
Riser Card	RSC-R1UTP-E16R	4	1U RHS Tw inPro Riser card with one PCI-E x16 slot
Heatsink / Retention	SNK-P0067PS	4	1U Passive CPU Heat Sink for X11 Purley Platform Equipped with a Narrow Retention Mechanism
Heatsink / Retention	SNK-P0067PSM	4	1U Passive CPU Heat Sink with a 26-mm Wide Middle Air Channel for X11 Purley Platform Equipped with a Narrow Retention Mechanism
Power Supply	PWS-2K20A-1R	2	1U 2200W Redundant, Titanium, 76(W) X 40(H) X 336(L) mm

Optional Parts List

	Part Number	Qty	Description
TPM security module (optional, not included)	AOM-TPM-9670V	1	SPI capable TPM 2.0 with Infineon 9670 controller with vertical form factor
TPM security module (optional, not included)	AOM-TPM-9671V	1	SPI capable TPM 1.2 with Infineon 9670 controller with vertical form factor
Add-on-Card	AOC-SMG3-2H8M2	-	AOC supports 2280 M.2 form factor SSD (1 NVMe or 2 SATA), FST-SCRW-0121L is included in AOC-SMG3-2H8M2
Global Services & Support	OS4HR3/2/1 OSNBD3/2/1	-	3/2/1-year onsite 24x7x4 service 3/2/1-year onsite NBD service
Software	SFT-OOB-LIC • @Store	1	OOB Management Package (per node license)
Software	SFT-DCMS-Single	1	DataCenter Management Package (per node license)